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FORM P	TO-1595 (modified)	11-27-2	2009 		IEET	4.S. DEPART Pat	MENT OF COMMERCE ent and Trademark Office
To the I	To the Honorable Assistant Secretary and Comr 103581			•1	he attached origin	nal document(s) or	copy(ies) thereof.
1	Name of conveying party(ies):	100001	2.	Name a	and address of re	eceiving party(ies	s):
	Ryusuke IKEMATSU		Name:		TEIJIN CHEI	MICALS, LTD.	
Additional name(s) of conveying party(ies) attached? No			Address:		2-1, Kasumiga Tokyo 100-00	aseki 3-chome, (013, Japan	Chiyoda-ku,
3.	Nature of conveyance:						
	X Assignment Merger Security Agreement Change Other						
Execut	ion Date: August 31, 2009		Additional 1	name(s) &	& address(es) attache	ed? No	
4.	Application number(s) or patent number	ber(s):	·		V		
If this	document is being filed together with a r	new application, the	execution of	date of	the application	is: <u>August 31, 2</u>	009
	A. Patent Application No.(s) NEW	Additional numb		B. No	Patent No.(s)		
5.	Name and address of party to whom concerning document should be maile	correspondence	T		umber of applic	ations and paten	ts involved: 1
	Name: WENDEROTH, LIND & POTAttn: Warren M. Cheek, Esq.	NACK, L.L.P.	7.	Total fe	ee (37 CFR 3.41)	\$40.00
	Street Address: 1030 15th Street, N.V.	dress: 1030 15th Street, N.W., Suite 400 East shington, State: DC ZIP: 20005-1503		[X] Au	closed (Check thorized to be cl	harged to)
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9.	Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.						
	Warren M. Cheek, Reg. No.33,367	Wal	cleek		<u>N</u>	ovember 23, 200)9
	Name of Person Signing	Signature			D	ate	· · · · · · · · · · · · · · · · · · ·
OMB No	o. 0651-0011 (exp. 4/94)				Total number	of pages includi	ng cover sheet: 3
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DOCKET NO. 2009_1699A

AP19 Rec'd PCT/PTO 23 NOV 2869 12/451630

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

In	sert	Nam	e(s)
of	Inve	entor	(s)

Ryusuke IKEMATSU residing at Chiyoda-ku, TOKYO, JAPAN

the undersigned hereby sell(s) and assign(s) to

Insert Name(s) of Assignee(s)

TEIJIN CHEMICALS, LTD.

2 1 Vagymigagaki 2 ahan

of 2-1, Kasumigaseki 3-chome, Chiyoda-ku, TOKYO 100-0013 JAPAN

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of Invention

Address

SLIDABLE RESIN COMPOSITION AND MOLDED ARTICLE THEREOF

for which an application for patent in the United States has been executed by the undersigned

Date of Signing of Application

on August 31, 2009

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, D.C. 20006-1021, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

PATENT REEL: 023573 FRAME: 0893

name(s).	-	igned on the date(s) opposite the undersigned
Date August 31, 2009	_, Name of the Ir	nventor Ryusuke Thematsu
		nventor
Date	_, Name of the Ir	nventor
Date	_, Name of the Ir	nventor
Date	_, Name of the In	nventor
Date	_, Name of the In	nventor
Date	_, Name of the In	nventor
Witness	ACKNOWL	EDGMENT
personally came the above-named	l me personally k knowledge to me	, 19, before me nown as the individual(s) who executed the that he (they) executed the same of his (their) own
SEAL		Official Signature
		Official Title
The above application may	be more particu	larly identified as follows:
U.S. Application Serial No.		Filing Date
Applicant Reference Number		Atty Docket No.

2

RECORDED: 11/23/2009

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